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|---|--|--|--|-----------------|--|------------|--|
| U.S. Department of Commerce, Patent and Trademark Office                                  |  |  |  | Atty Docket No. |  | Serial No. |  |
|   |  |  |  | M-15223 US      |  | 10/632,007 |  |
| <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b><br>(Use several sheets if necessary) |  |  |  | Applicant       |  |            |  |
|   |  |  |  | Yi Ding         |  |            |  |
|   |  |  |  | Filing Date     |  | Group      |  |
|   |  |  |  | July 30, 2003   |  | 2822       |  |

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| U.S. Patent Documents |    |                 |              |               |       |          |                            |
|-----------------------|----|-----------------|--------------|---------------|-------|----------|----------------------------|
| *Examiner Initial     |    | Document Number | Date         | Name          | Class | Subclass | Filing Date If Appropriate |
|                       | AA | 6,420,231       | 16 Jul. 2002 | Harari et al. |       |          |                            |
|                       | AB |                 |              |               |       |          |                            |
|                       | AC |                 |              |               |       |          |                            |
|                       | AD |                 |              |               |       |          |                            |
|                       | AE |                 |              |               |       |          |                            |
|                       | AF |                 |              |               |       |          |                            |
|                       | AG |                 |              |               |       |          |                            |
|                       | AH |                 |              |               |       |          |                            |

| Foreign Patent Documents |    |          |      |         |       |          | Translation |    |
|--------------------------|----|----------|------|---------|-------|----------|-------------|----|
|                          |    | Document | Date | Country | Class | Subclass | Yes         | No |
|                          | AI |          |      |         |       |          |             |    |
|                          | AJ |          |      |         |       |          |             |    |
|                          | AK |          |      |         |       |          |             |    |
|                          | AL |          |      |         |       |          |             |    |

| OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.) |    |  |
|--|----|--|
|  | AM | United States Patent Application No. 10/798,475, entitled "Fabrication of Conductive Lines Interconnecting Conductive Gates in Nonvolatile Memories and Non-Volatile Memory Structures," Filed on March 10, 2004; Attorney Docket No. M-15296 US.  |
|  | AN | United States Patent Application No. 10/797,972, entitled "Fabrication of Conductive Lines Interconnecting First Conductive Gates in Nonvolatile Memories Having Second Conductive Gates Provided By Conductive Gates Lines, Wherein The Adjacent Conductive Gate Lines For The Adjacent Columns Are Spaced From Each Other, And Non-Volatile Memory Structures," Filed on March 10, 2004; Attorney Docket No. M-15297 US. |
|  | AO |  |
|  | AP |  |

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| Examiner | Date Considered 10/1/04 |
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.

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|                       | AF |                 |              |               |       |          |                            |
|                       | AG |                 |              |               |       |          |                            |
|                       | AH |                 |              |               |       |          |                            |

  

| Foreign Patent Documents |    |          |      |         |       |          | Translation |    |
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|                          |    | Document | Date | Country | Class | Subclass | Yes         | No |
|                          | AI |          |      |         |       |          |             |    |
|                          | AJ |          |      |         |       |          |             |    |
|                          | AK |          |      |         |       |          |             |    |
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